

Micro- & Nano-Technologies Enabling More Compact, Lightweight Thermoelectric Power Generation & Cooling Systems

2012 3rd Thermoelectrics Applications Workshop

San Diego, CA

21 March 2012

Terry J. Hendricks¹ , Shankar Krishnan²

**¹Battelle Memorial Institute
Process & Systems Engineering
Columbus, OH**

**²Pacific Northwest National Laboratory
Energy & Efficiency Division
MicroProducts Breakthrough Institute
Corvallis, OR**

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EERE - Office of Vehicle Technologies**



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Motivation - Energy & The Environment

➤ Transportation Sector Energy Use

➤ Light-Duty Passenger Vehicles + Light-Duty Vans/Trucks (SUVs)¹

2002: 16.27 Quads of Fuel Usage

2008: 16.4 Quads of Fuel Usage

2002: ~ 5.7 quads/yr exhausted down the tail pipe

~ 5 quads/yr rejected in coolant system

➤ Medium & Heavy-Duty Vehicles¹

2002: 5.03 Quads of Fuel Usage

2008: 5.02 Quads of Fuel Usage

~1.5 quads/yr exhausted down the tail pipe

➤ 7 to 8 Billion gallons of fuel /year used for Automotive A/C

➤ Hybrid Electric Vehicles

Move Toward Electrification – Micro, Mild, and Full

➤ Needs for On-board Power Generation

➤ Needs for Electric-Driven Cooling



➤ Environmental Impact

➤ Reduce Global Warming Refrigerant Use in Automotive A/C Systems

➤ R-134 a Leakage - Global Warming Impact - 1,300 times that of carbon dioxide

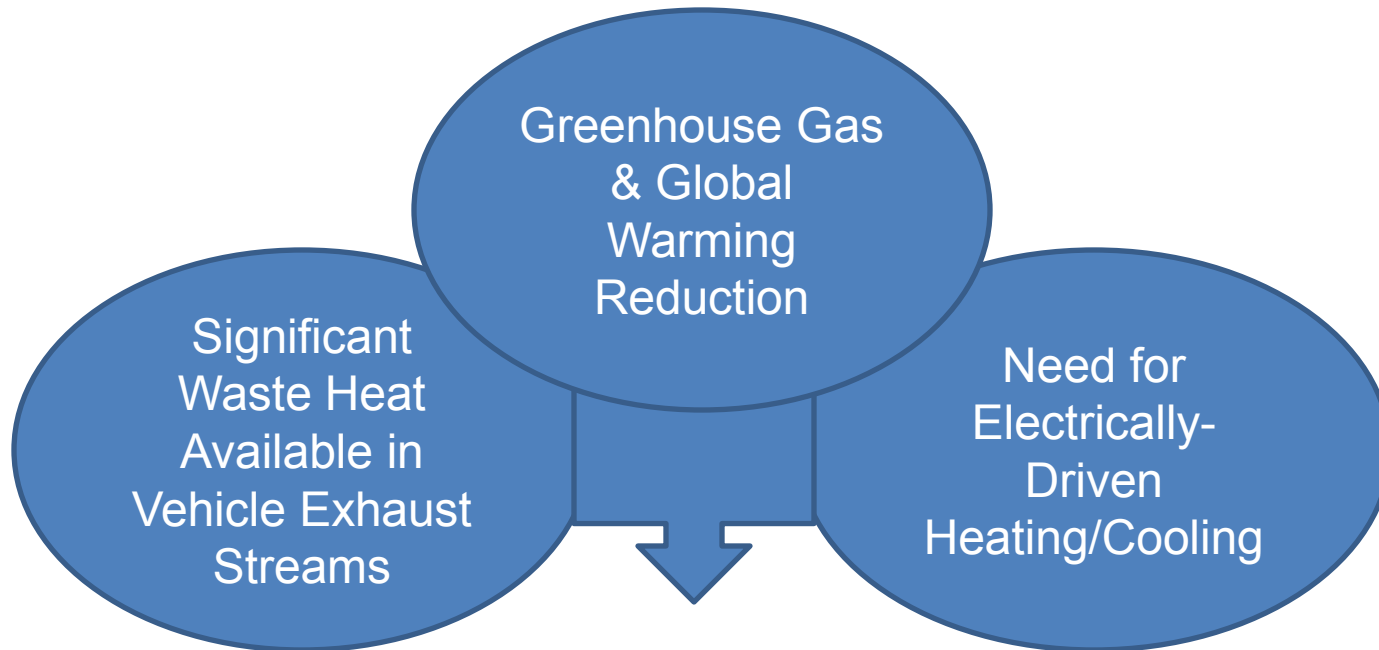
¹Transportation Energy Data Book, 2010, Edition 29, U.S. Department of Energy, Office of Energy Efficiency and Renewable Energy, Vehicles Technology Program. ORNL-6985, Oak Ridge National Laboratory, Oak Ridge, Tennessee. <http://cta.ornl.gov/data/index.shtml>.

Motivation - Energy & The Environment

- **7 to 8 Billion gallons of fuel /year used for Automotive A/C**
 - ~6 % of Light Duty Vehicle Fuel Use; Releases approximately 62-70 Billion kg of CO₂ / year
- **Current Centralized A/C Systems Require 3.5 to 5 kW of Energy in Each Vehicle**
- **Zonal or Distributed Thermoelectric Heating, Ventilation and Air Conditioning (HVAC)**
 - Requires ~ 630 Watts Cool Driver Only and
 - ~ 2.7 kW Cool 5 Occupants
- **In Heating Mode, TE much more Efficient ($COP_{heat} \sim 2.3 > 1$)**
- **Current Vehicular Air Conditioner (A/C) uses Compressed R134-a Refrigerant Gas**
 - Each Vehicle Leaks ~70 g/year R134-a
 - R134-a Has 1300 times the “Greenhouse Gas Effect” as Carbon Dioxide (CO₂)
 - ~18.2 Million Metric Tons of CO₂ equivalent/year from personal vehicles in the US from operating air conditioners (does not include accident release)
 - U.S. EPA Estimates ~58 Million Metric Tons of CO₂ equivalent/year from transportation sector (primarily R-134a)

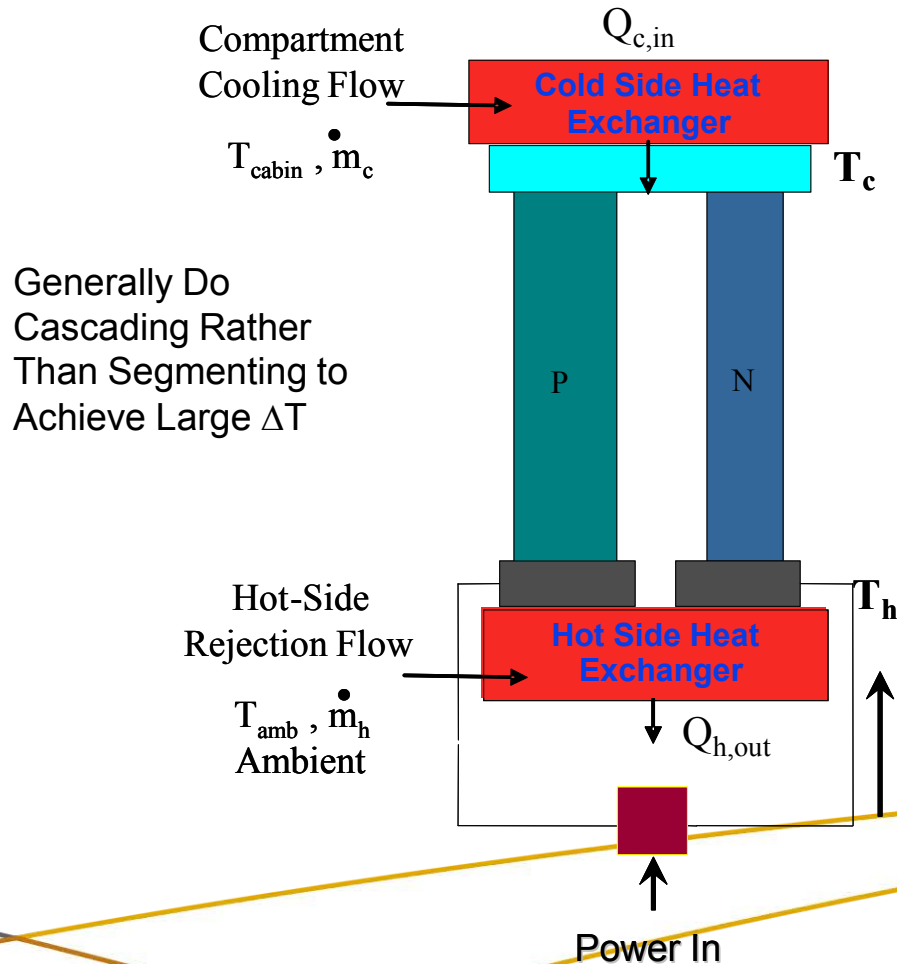
Thermoelectric Systems in Automobiles

➤ DOE Sees a Vision and the Potential



Advanced Thermoelectric System Design

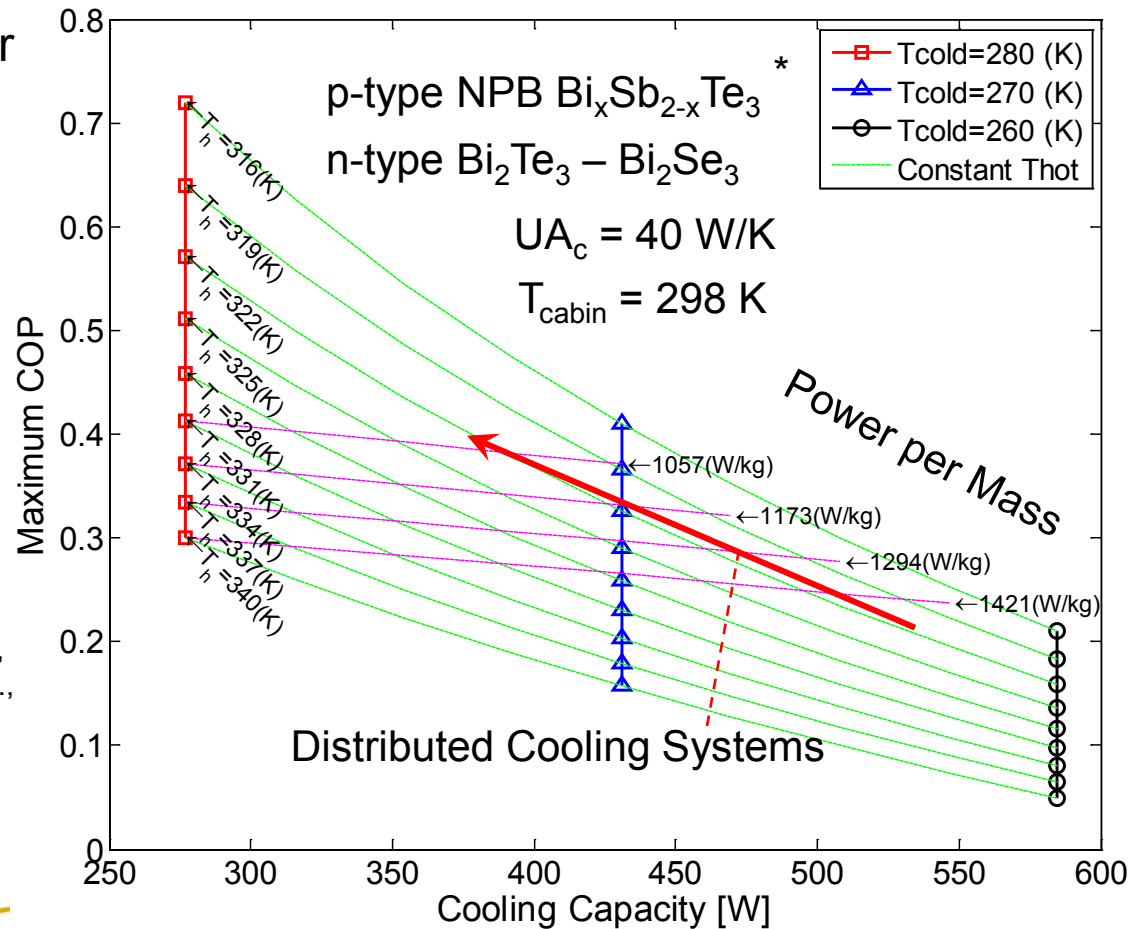
Thermoelectric Heating/Cooling Low-Temperature Systems



TE Cooling

Heat Exchanger / TE Device Integration Requirements

- Typical COP – Cooling Capacity – Power / Mass Relationship Shown
- Distributed TE Cooling Systems
 - Create Lower Heat Flows per Unit
 - Higher COP's
 - Lower Power / Mass
- Generally Right Directions for Automotive Distributed Cooling

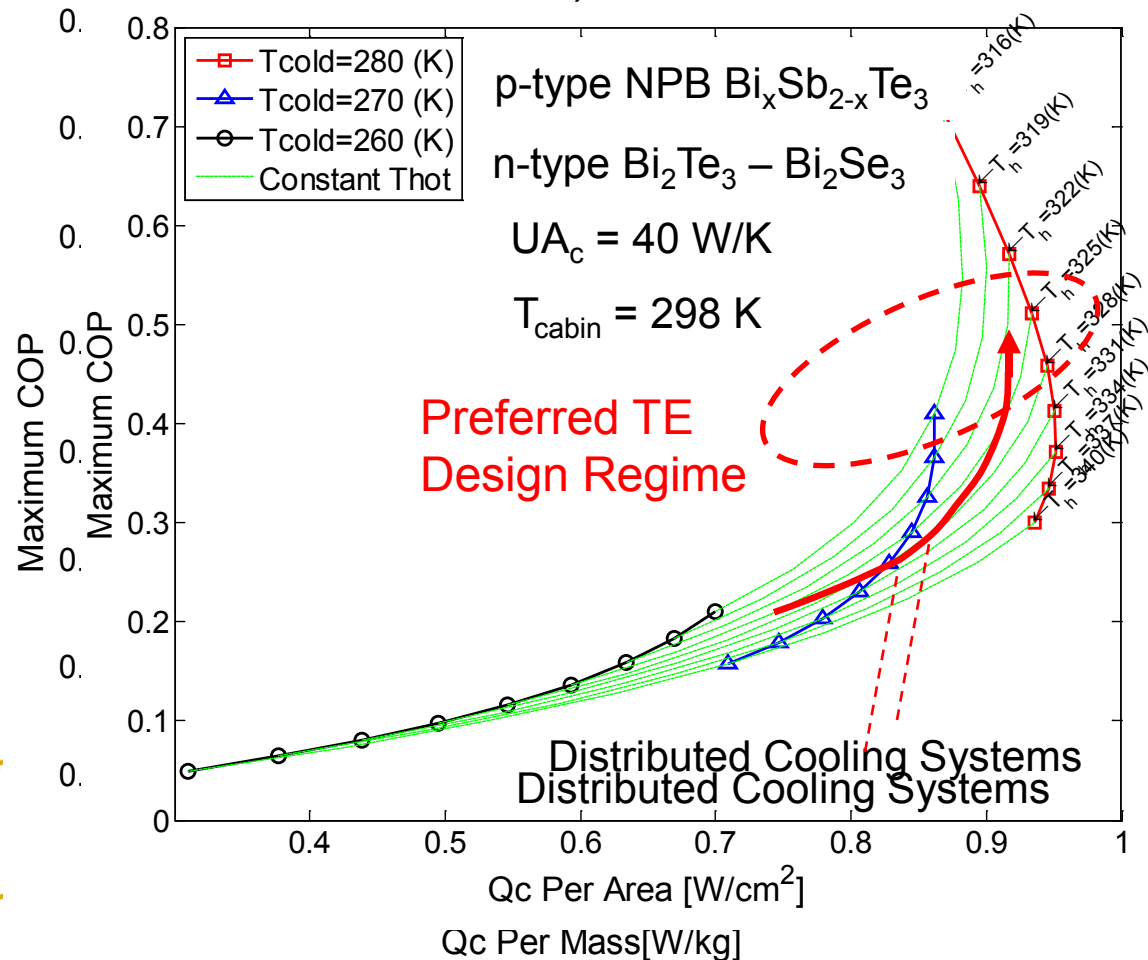


* Poudel, B., Hao, Q.H., Ma, Y., Lan, Y., Minnich, A. Yu, B., Yan, X., Wang, D., Muto, A., Vashaee, D., Chen, X., Liu, J., Dresselhaus, M.S., Chen, G., Ren, Z., 2008, "High-Thermoelectric Performance of Nanostructured Bismuth Antimony Telluride Bulk Alloys," *Scienceexpress*, 10.1126, science.1156446.

TE Cooling

Heat Exchanger / TE Device Integration Requirements

- Distributed TE Cooling Systems Generally Move Into Regions of:
 - Higher COP's
 - Higher Specific Cooling Capacity (Compact, Lightweight Systems)
 - Higher Heat Fluxes (Higher Heat Transfer Coefficients)
- Generally Higher Performance Heat Exchanger Systems Required

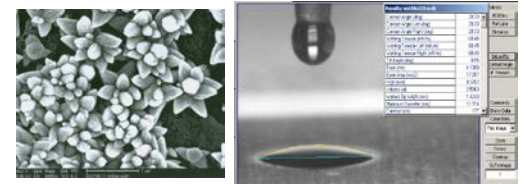


MicroTechnology in Distributed TE HVAC Systems

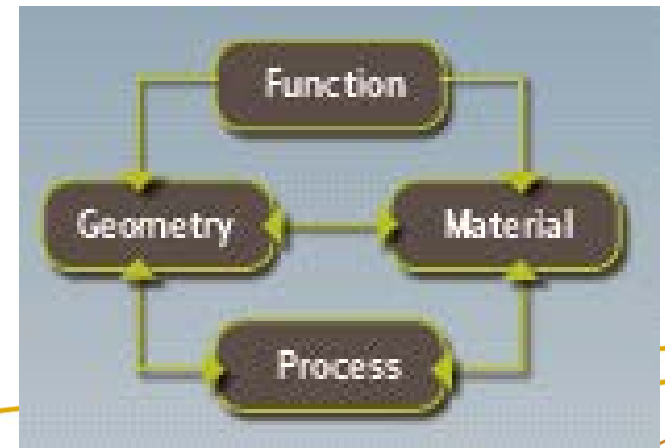
- DOE Project in Advanced TE HVAC Systems for Automobiles
 - Zonal Climate Control for Thermal Comfort
 - Compact Microtechnology Heat Exchangers
 - Reduce Weight & Volume
 - Low Cost Manufacturing
 - Coupled with Compact TE HVAC Systems
 - Wicking Systems for Water Management
 - Leveraging Nano-Scale Coating Technology
 - Significant Microtechnology Cost Modeling
 - Cost Sensitivities Identified
 - Low-Cost Manufacturing Avenues Being Developed
 - Sensitivities to Production Volumes
 - Material and Process Cost Drivers



Hybrid / PHEV Vehicles



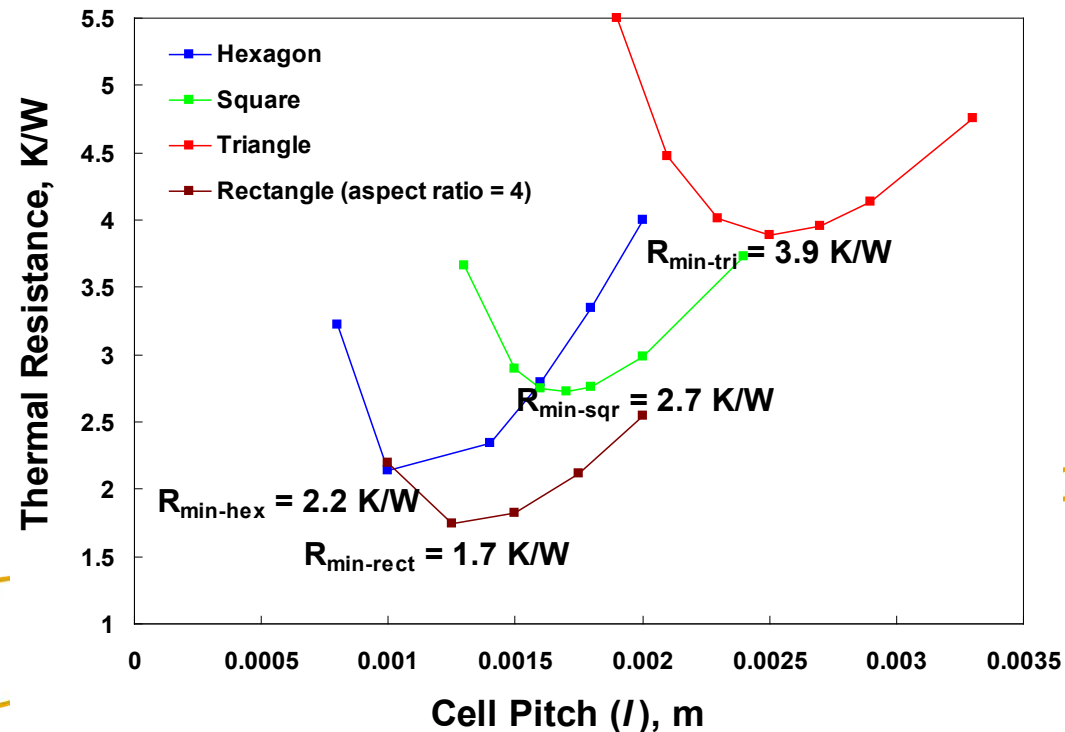
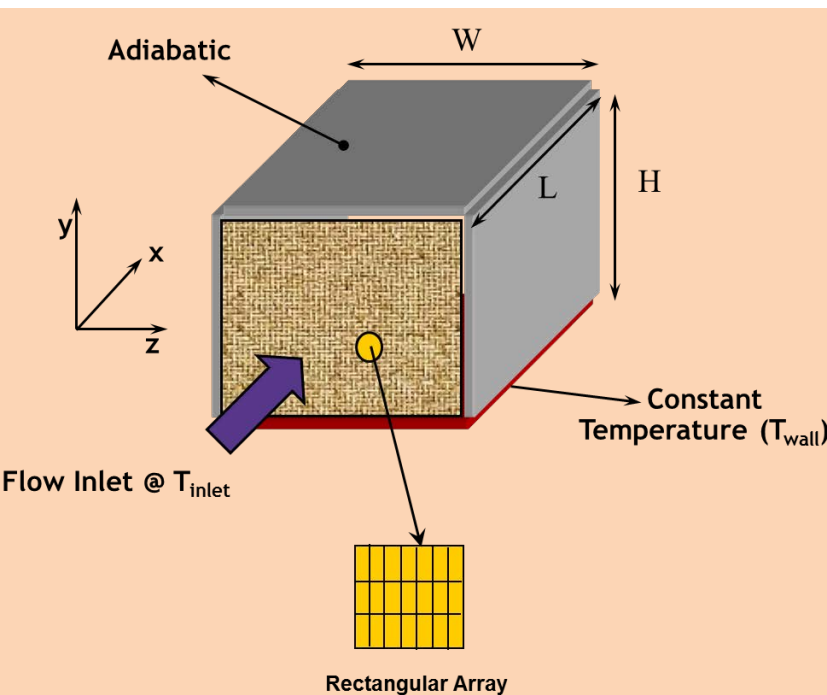
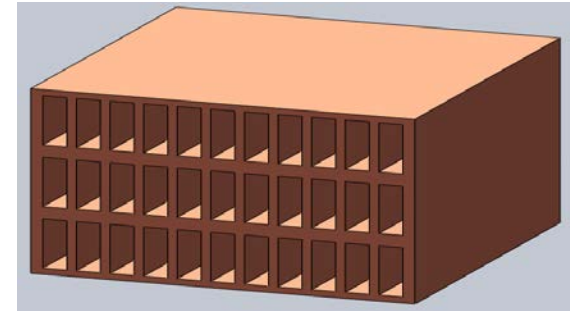
Nano-Scale Coatings



Cost Modeling Approach

PNNL Developing High-Performance Microtechnology Heat Transfer Technologies

- TE Cooling / Heating
 - Automotive Distributed HVAC Systems
 - A Number of Microtechnology Designs Are Being Investigated
 - An Example of One Such Design Is Presented Here
- Established geometry, heat transfer and pressure drop characteristics
- Semi-empirical modeling & COMSOL Modeling



Process Based Cost Modeling

Bottom-Up Approach to Estimating Cost of Goods Sold (COGS)

Based on Operation of Virtual Manufacturing Line – Breaks Down Cost by Unit Process

Model Inputs

Process Flow

Unit Process 1
Unit Process 2
Unit Process 3
Etc.

Cost Elements

Capital Equipment
Labor
Materials
Energy
Facilities
Maintenance



Process-Based Cost
Model Algorithm

Not Included
Overhead & Profit
Insurance
Taxes
Inventory Management
Accounting
Marketing
Sales

Model Outputs

Cost of Goods Sold (COGS)

Fixed Costs

Capital Equipment
Maintenance
Facilities/Buildings

Variable Costs

Direct Labor
Direct Materials
Indirect Materials
Utilities

Process COGS vs. Volume and Pareto

Cost Sensitivity

ID Cost Drivers

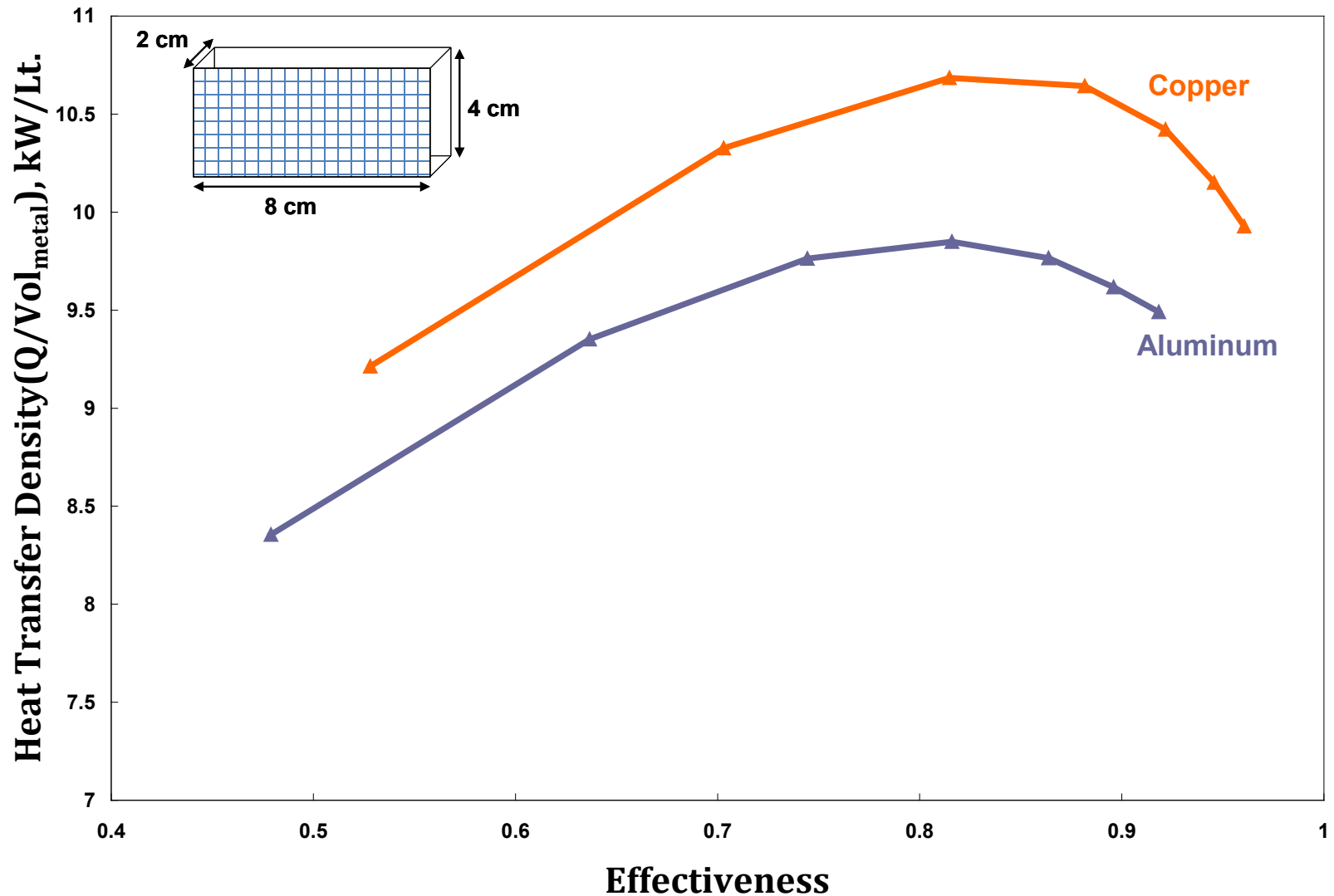
Process to Process Comparisons

Define Fabrication Toolbox

Inform R&D Agenda

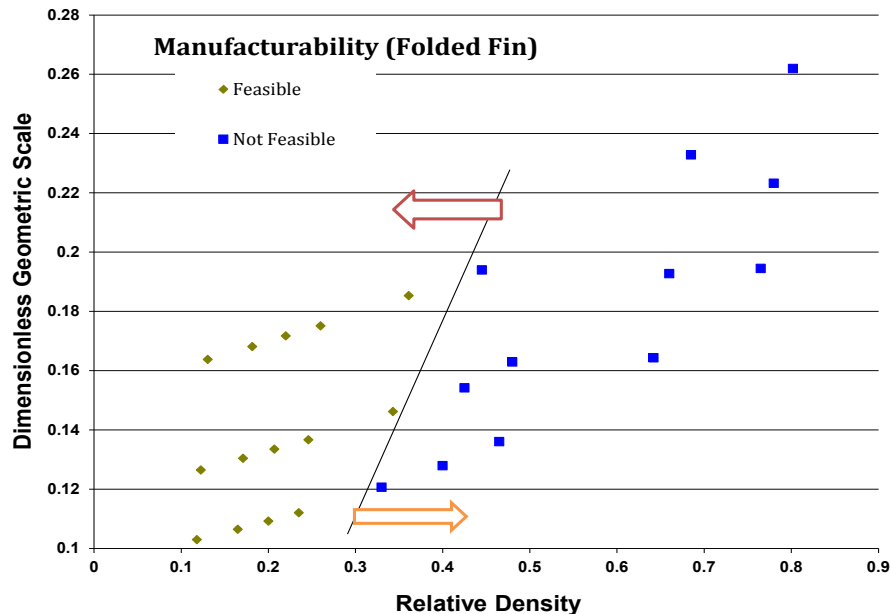
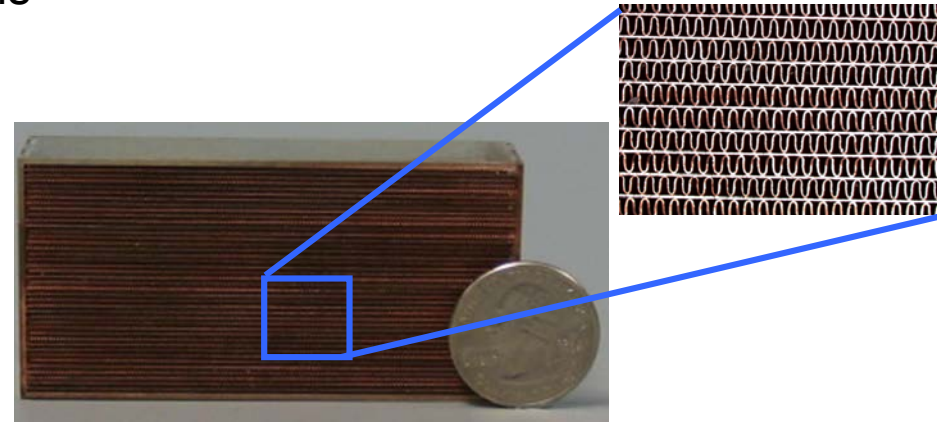
Start with Process Flow and Associated Equipment Set

Effect of Channel Aspect Ratio on Flux Density

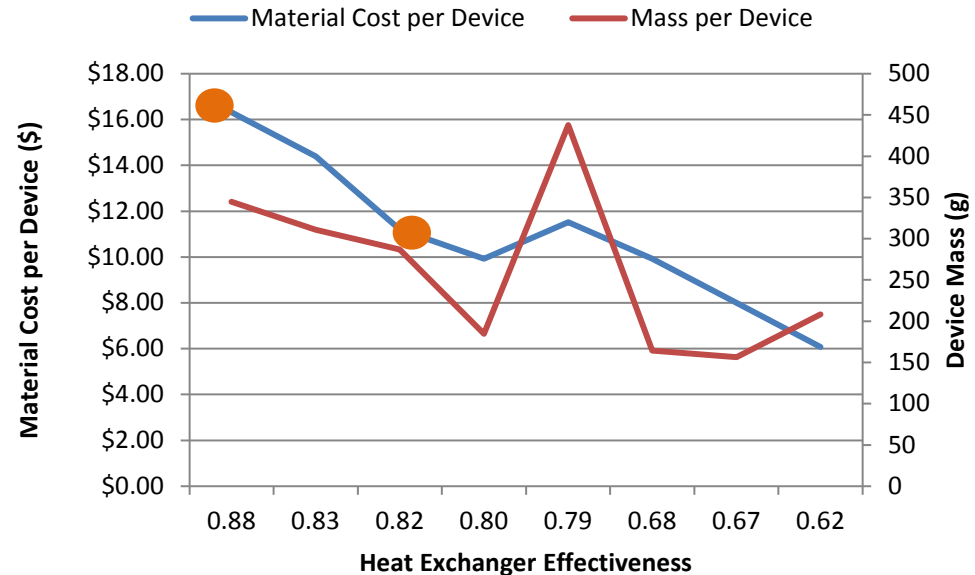


Cost Vs Performance

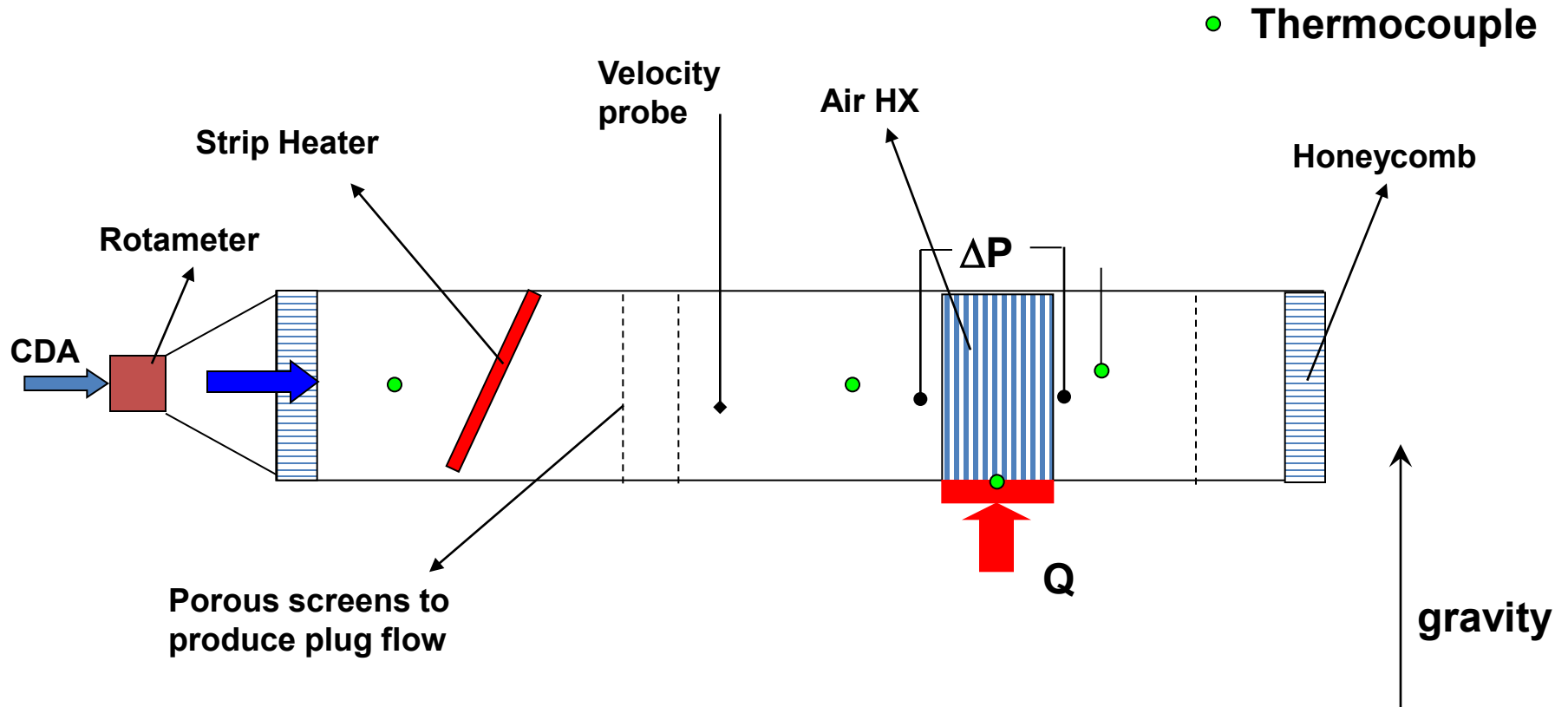
- Layered Rectangular Honeycomb Designs
- Fine Pitch Design (#1)
 - Higher Fin Density
 - Higher Performance ($\varepsilon = 0.88$)
 - Somewhat Higher Cost
- Coarse Pitch Design (#2)
 - Lower Fin Density
 - Slightly Lower Performance ($\varepsilon = 0.81$)
 - Lower Cost
- Manufacturability, Process and Cost Drivers Identified



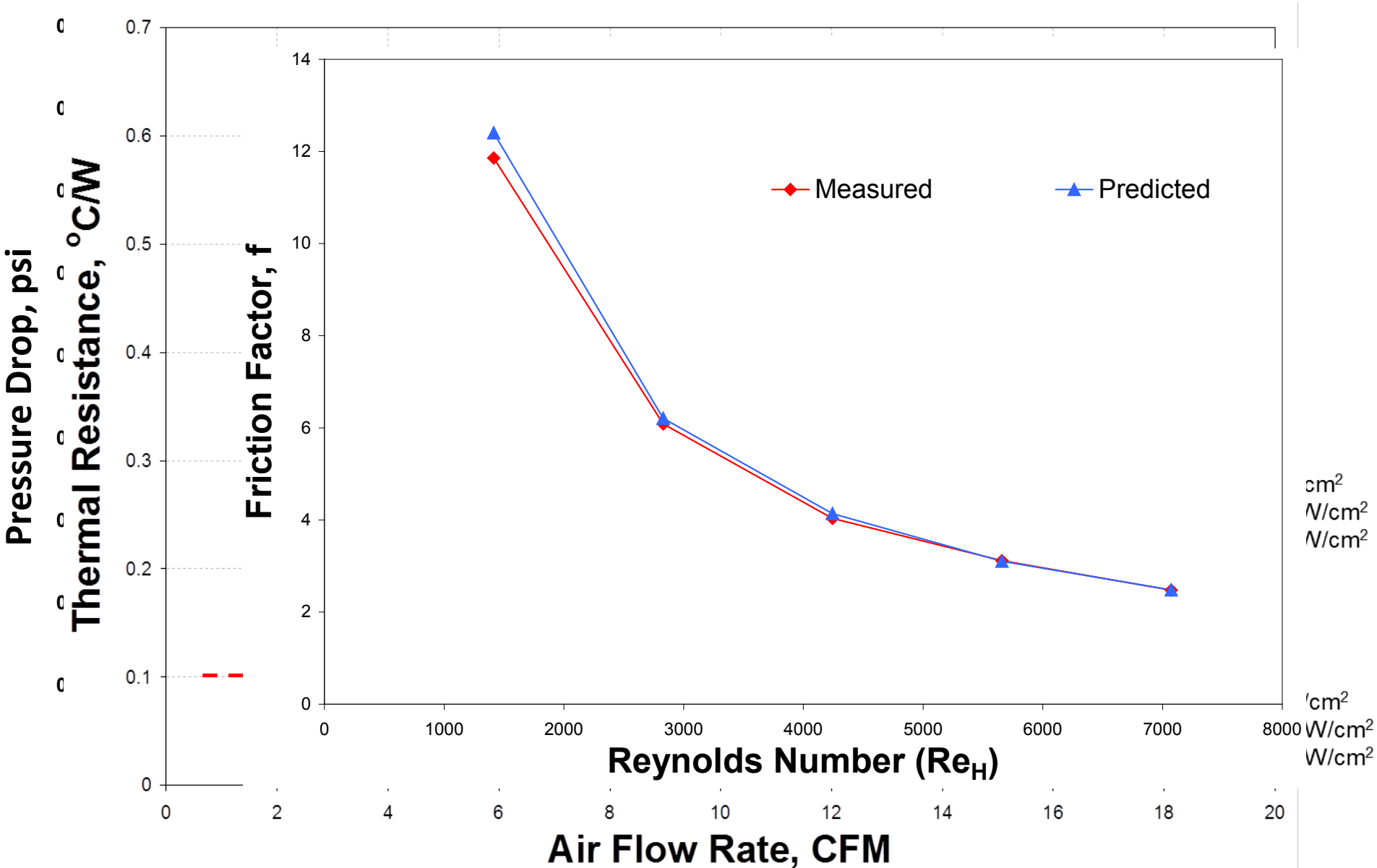
Cu Folded Fin HTX Cost vs. Performance



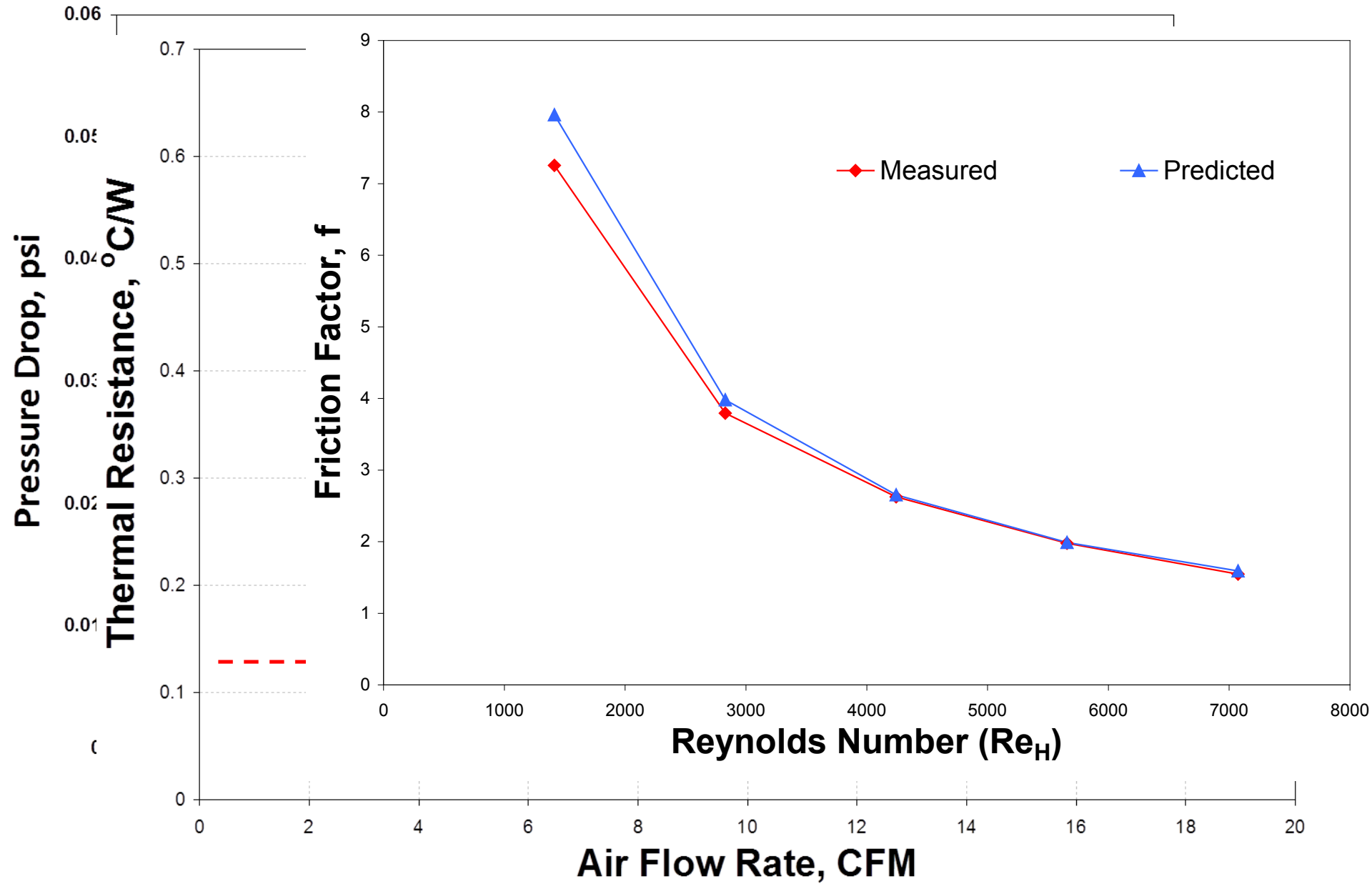
Air-Side Heat Transfer Experiments



Design #1: Fine Pitch – Tested Performance & Correlation with Models



Design #2: Coarse Pitch – Tested Performance & Correlations with Models



Cost Comparison

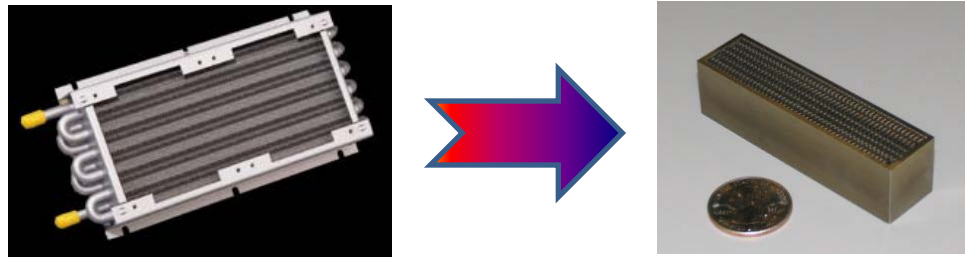
Metrics	Design #1	Design #2
\$/effectiveness	\$18.55	\$13.66
\$/W	\$0.055	\$0.041
\$/kg	\$47.32	\$39.05

Observations & Findings

- Accounted for braze thickness and separator plate thickness based on variation in heat exchanger stack height
- Measured thermal resistance came out to be higher than predicted thermal resistance
- Friction factor & pressure drop correlated well with fluid dynamic models
- Model thermal predictions may be conservative (lower performance bound). Higher performance bound will be ~ 3% lower than the predicted thermal resistance
- Discrepancy between thermal model and measurements could be due to
 - Geometric variation in the built device
 - Delaminated layers in heat exchangers
 - Measurement errors
 - Modeling assumptions compared to actual fabricated devices

Summary

- Microtechnology Thermal Systems Required to Enable Compact, Lightweight TE Systems
 - TE Power Generation – Energy Recovery and Portable Power Applications
 - TE Cooling / Heating – Distributed Automotive Applications
- Microtechnology Thermal Systems Successfully Integrating into TE Systems



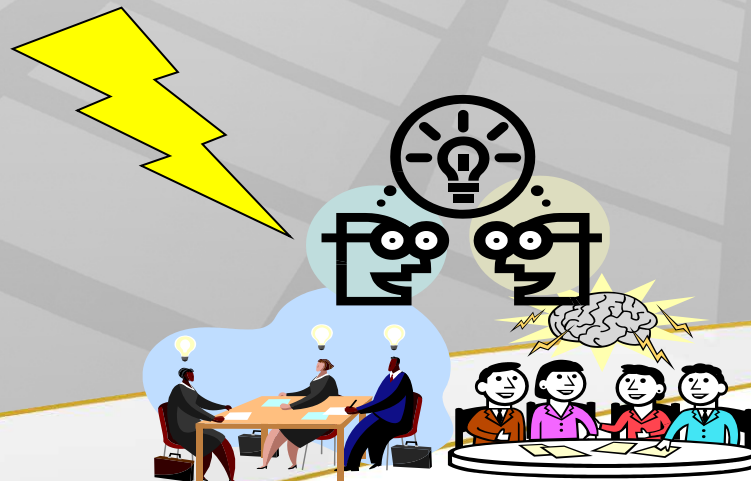
- Process-Based Cost Modeling Has Identified High- and Low-Cost Manufacturing Pathways, Processes, and Materials
 - High-Cost Designs Differentiated from Low-Cost Designs
 - Performance vs. Cost Clearly Delineated
- System Performance Modeling Integrated with Process-Based Cost Modeling
 - Powerful Combination Identifies Low-Cost, Manufacturable Microtechnology Designs
- Prioritizes R&D Investment Plans & Enables Business Decisions

Thank you for your time and interest

We are What We Repeatedly do. Excellence, Then, is not an Act, But a Habit.

Aristotle

Questions & Discussion



ADDITIONAL BACKUP TOPICS

System Analysis Capabilities & Characteristics

- System-Level Couples Design Analysis of:
 - Hot Side Heat Exchanger Performance
 - TE Device Performance
 - Cold Side Heat Exchanger Performance
- Single or Segmented TE Material Legs
- Accounts for Hot/Cold Thermal Resistances
- Accounts for Electrical Contact Resistances
- Optimum Heat Exchanger / TE Design Parameters Determined Simultaneously
- Maximum Efficiency or COP & Maximum Power or Cooling Capacity Designs Are Possible
- Off-Nominal & Variable Condition Performance Analysis